

# IGBT - Power, Co-PAK N-Channel, Field Stop VII (FS7), TO247-4L 1200 V, 1.7 V, 140 A

## **FGY4L140T120SWD**

#### Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 4-lead package, FGY4L140T120SWD offers the optimum performance with low switching and conduction losses for high-efficiency operations in various applications like Solar Inverter, UPS and ESS.

#### **Features**

- Maximum Junction Temperature  $T_J = 175^{\circ}C$
- Positive Temperature Coefficient for Easy Parallel Operation
- High Current Capability
- Smooth and Optimized Switching
- Low Switching Loss
- RoHS Compliant

### **Applications**

- Solar Inverter
- UPS
- Energy Storage System

## **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise noted)

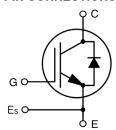
Param	Symbol	Value	Unit		
Collector-to-Emitter Volt	V <sub>CE</sub>	1200	V		
Gate-to-Emitter Voltage		$V_{GE}$	±20		
Transient Gate-to-Emitte	er Voltage		±30		
Collector Current	T <sub>C</sub> = 25°C (Note 1)	I <sub>C</sub>	200	Α	
	T <sub>C</sub> = 100°C	]	140		
Power Dissipation	T <sub>C</sub> = 25°C	$P_{D}$	1250	W	
	T <sub>C</sub> = 100°C	]	625		
$ \begin{array}{ccc} \text{Pulsed Collector} & & & T_{C} = 25^{\circ}\text{C}, \\ \text{Current} & & t_{p} = 10 \; \mu\text{s} \; (\text{Note 2}) \\ \end{array} $		I <sub>CM</sub>	560	Α	
Diode Forward	T <sub>C</sub> = 25°C (Note 1)	I <sub>F</sub>	200		
Current	T <sub>C</sub> = 100°C		140		
Pulsed Diode Forward $T_C = 25^{\circ}C$ , $t_p = 10 \mu s$ (Note 2)		I <sub>FM</sub>	560		
Operating Junction and S Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C		
Lead Temperature for So	TL	265			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Value limited by bond wire
- 2. Repetitive rating: Pulse width limited by max. junction temperature.

BV <sub>CES</sub>	V <sub>CE(SAT)_TYP</sub>	lc
1200 V	1.7 V	140 A

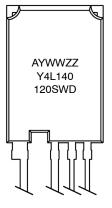
#### **PIN CONNECTIONS**





TO-247-4LD CASE 340BW

#### **MARKING DIAGRAM**



A = Assembly Location
YWW = Date code (Year & week)
ZZ = Assembly Lot
Y4L140120SWD = Specific Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping		
FGY4L140T120SWD	TO-247-4LD (Pb-Free)	30 Units / Tube		

## THERMAL CHARACTERISTICS

		Value			
Parameter		Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case for IGBT		_	0.09	0.12	°C/W
Thermal Resistance, Junction-to-Case for Diode		_	0.15	0.2	
Thermal Resistance, Junction-to-Ambient		-	_	40	

# ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise noted)

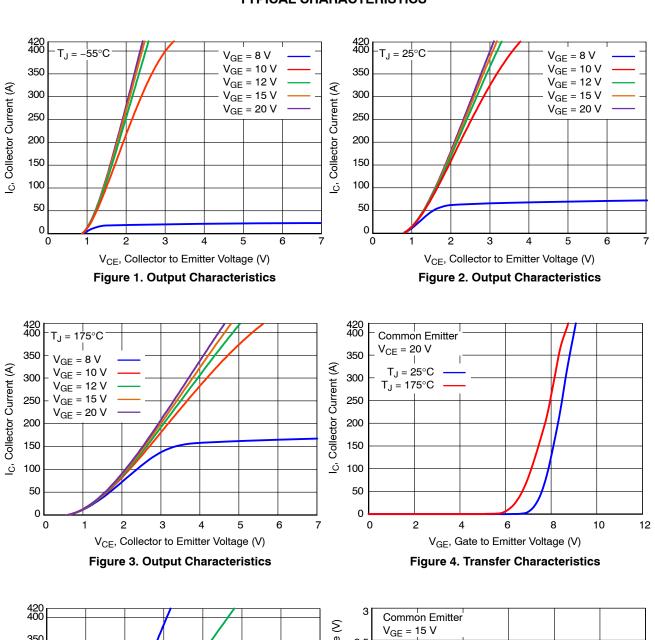
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector-to-Emitter Breakdown Voltage	BV <sub>CES</sub>	$V_{GE} = 0 \text{ V}, I_{C} = 1 \text{ mA}$	1200	-	-	V
Breakdown Voltage Temperature Coefficient	$\Delta BV_CES$	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 9.99 mA	-	1256	-	mV/°C
	$\Delta T_{J}$					
Collector-to-Emitter Cut-Off Current	I <sub>CES</sub>	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = V <sub>CES</sub>	-	-	40	μΑ
Gate-to-Emitter Leakage Current	I <sub>GES</sub>	$V_{GE} = \pm 20 \text{ V}, V_{CE} = 0 \text{ V}$	ı	-	±400	nA
ON CHARACTERISTICS						
Gate-to-Emitter Threshold Voltage	V <sub>GE(th)</sub>	$V_{GE} = V_{CE}$ , $I_C = 140 \text{ mA}$	5.6	6.5	7.4	V
Collector-to-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 140 A, T <sub>J</sub> = 25°C	-	1.7	2.0	
		V <sub>GE</sub> = 15 V, I <sub>C</sub> = 140 A, T <sub>J</sub> = 175°C	-	2.4	-	
DYNAMIC CHARACTERISTICS						
Input Capacitance	C <sub>ies</sub>	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 1 MHz	-	13600	-	pF
Output Capacitance	C <sub>oes</sub>		-	389	-	
Reverse Transfer Capacitance	C <sub>res</sub>		-	53.2	-	
Total Gate Charge	Qg	V <sub>CE</sub> = 600 V, V <sub>GE</sub> = 15 V, I <sub>C</sub> = 140 A	-	426	-	nC
Gate-to-Emitter Charge	Q <sub>ge</sub>	IC = 140 A	-	114	-	
Gate-to-Collector Charge	Q <sub>gc</sub>		-	148	-	
SWITCHING CHARACTERISTIC, INDUCTIVI	E LOAD					
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{CE}$ = 600 V, $V_{GE}$ = 15 V $I_{C}$ = 70 A $R_{G}$ = 4.7 $\Omega$ $T_{J}$ = 25°C	-	56	-	ns
Rise Time	t <sub>r</sub>	IC = 70 A MG = 4.7 \$2 IJ = 25°C	-	16	-	
Turn-off Delay Time	t <sub>d(off)</sub>		-	254.4	-	
Fall Time	t <sub>f</sub>		-	65.6	-	
Turn-on Switching Loss	E <sub>on</sub>		ı	2.2	-	mJ
Turn-off Switching Loss	E <sub>off</sub>		ı	2.1	-	
Total Switching Loss	E <sub>ts</sub>		ı	4.2	-	
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{CE}$ = 600 V, $V_{GE}$ = 15 V $I_{C}$ = 140 A $R_{G}$ = 4.7 $\Omega$ $T_{J}$ = 25°C	ı	60.8	-	ns
Rise Time	t <sub>r</sub>	IC = 140 A HG = 4.7 \( \Omega \) IJ = 25 \( \Omega \)	-	27.2	-	
Turn-off Delay Time	t <sub>d(off)</sub>		-	232	-	
Fall Time	t <sub>f</sub>		-	57.6	-	
Turn-on Switching Loss	E <sub>on</sub>		ı	3.9	-	mJ
Turn-off Switching Loss	E <sub>off</sub>		ı	4.6	-	
Total Switching Loss	E <sub>ts</sub>		-	8.5	_	

## **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTIC, INDU	CTIVE LOAD					-
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>CE</sub> = 600 V, V <sub>GE</sub> = 15 V	-	49.6	-	ns
Rise Time	t <sub>r</sub>	$I_C = 70 \text{ A R}_G = 4.7 \ \Omega T_J = 175 ^{\circ}\text{C}$	-	22.4	-	1
Turn-off Delay Time	t <sub>d(off)</sub>		-	305.6	-	1
Fall Time	t <sub>f</sub>		-	107.2	-	1
Turn-on Switching Loss	E <sub>on</sub>		-	4.8	1	mJ
Turn-off Switching Loss	E <sub>off</sub>		-	3.0	-	
Total Switching Loss	E <sub>ts</sub>		-	7.9	1	1
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{CE}$ = 600 V, $V_{GE}$ = 15 V $I_{C}$ = 140 A $R_{G}$ = 4.7 $\Omega$ $T_{J}$ = 175°C	-	52.8	-	ns
Rise Time	t <sub>r</sub>	$I_{\rm C} = 140  \text{A H}_{\rm G} = 4.7  \Omega  I_{\rm J} = 175 ^{\circ} \text{C}$	-	35.2	-	1
Turn-off Delay Time	t <sub>d(off)</sub>		-	280	-	
Fall Time	t <sub>f</sub>		-	99.6	1	1
Turn-on Switching Loss	E <sub>on</sub>		-	8.6	1	mJ
Turn-off Switching Loss	E <sub>off</sub>		-	7.0	-	
Total Switching Loss	E <sub>ts</sub>		-	15.5	-	1
DIODE CHARACTERISTICS						
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 140 A, T <sub>J</sub> = 25°C	1.74	2.04	2.34	V
		I <sub>F</sub> = 140 A, T <sub>J</sub> = 175°C	-	2.2	ı	
DIODE SWITCHING CHARACTERISTIC	S, INDUCTIVE LO	DAD				
Reverse Recovery Time	t <sub>rr</sub>	V <sub>R</sub> = 600 V, I <sub>F</sub> = 70 A,	-	192.4	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	dl <sub>F</sub> /dt = 1000 A/μs, T <sub>J</sub> = 25°C	-	4.4	1	μC
Reverse Recovery Energy	E <sub>REC</sub>	]	-	1.5	-	mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>	]	-	45.9	-	Α
Reverse Recovery Time	t <sub>rr</sub>	V <sub>R</sub> = 600 V, I <sub>F</sub> = 140 A,	-	266.9	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	dl <sub>F</sub> /dt = 1000 A/μs, T <sub>J</sub> = 25°C	-	6.95	-	μC
Reverse Recovery Energy	E <sub>REC</sub>	]	-	2.4	-	mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>	]	-	52.4	-	Α
Reverse Recovery Time	t <sub>rr</sub>	$V_R = 600 \text{ V}, I_F = 70 \text{ A},$	-	304.6	1	ns
Reverse Recovery Charge	Q <sub>rr</sub>	dI <sub>F</sub> /dt = 1000 A/μs, T <sub>J</sub> = 175°C	-	10.6	-	μC
Reverse Recovery Energy	E <sub>REC</sub>		-	3.9	-	mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>		-	68.7	1	Α
Reverse Recovery Time	t <sub>rr</sub>	$V_R = 600 \text{ V}, I_F = 140 \text{ A},$	-	431.9	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$dI_F/dt = 1000 \text{ A/µs}, T_J = 175^{\circ}\text{C}$	_	16.3	-	μC
Reverse Recovery Energy	E <sub>REC</sub>	1	-	6.1	_	mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>	1	_	76.6	_	Α

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL CHARACTERISTICS**



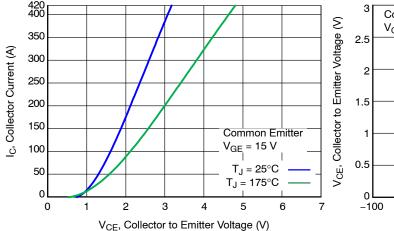


Figure 5. Saturation Characteristics

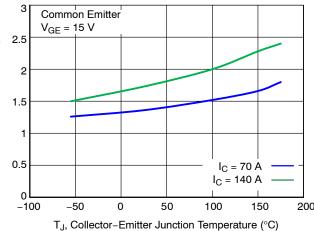


Figure 6. Saturation Voltage vs. Junction Temperature

#### **TYPICAL CHARACTERISTICS**

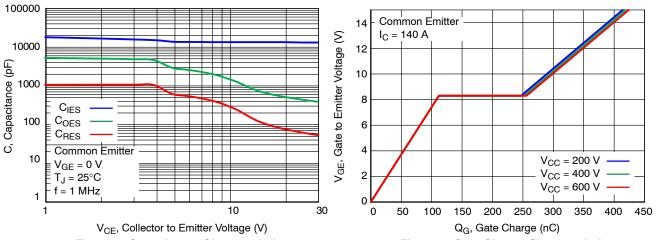


Figure 7. Capacitance Characteristics

Figure 8. Gate Charge Characteristics

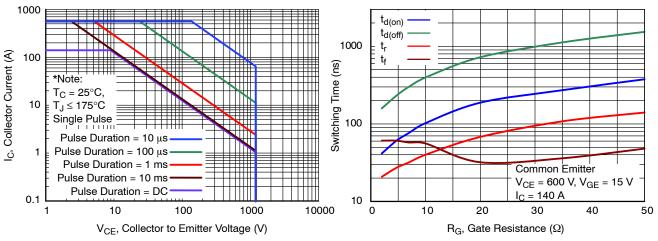


Figure 9. SOA Characteristics

Figure 10. Switching Time vs. Gate Resistance  $(T_J = 25^{\circ}C)$ 

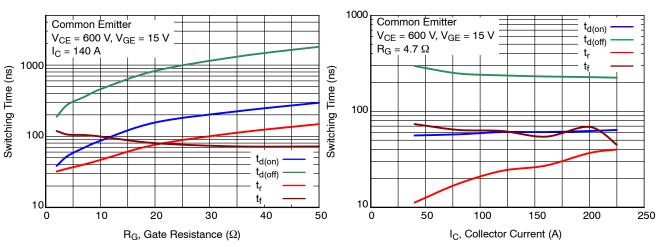


Figure 11. Switching Time vs. Gate Resistance  $(T_J = 175^{\circ}C)$ 

Figure 12. Switching Time vs. Collector Current  $(T_J = 25^{\circ}C)$ 

#### **TYPICAL CHARACTERISTICS**

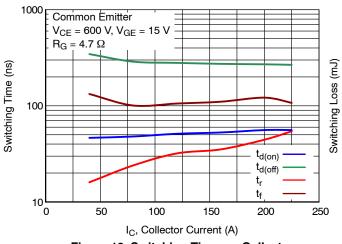


Figure 13. Switching Time vs. Collector Current ( $T_J = 175$ °C)

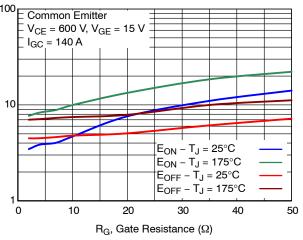


Figure 14. Switching Loss vs Gate Resistance

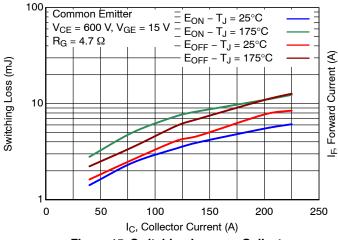


Figure 15. Switching Loss vs. Collector Current

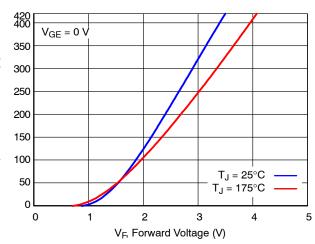


Figure 16. Diode Forward Characteristics

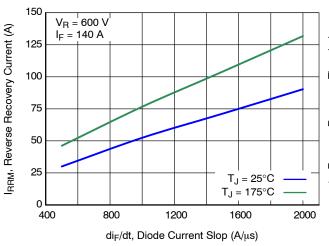


Figure 17. Diode Reverse Recovery Current

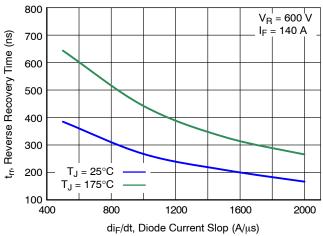


Figure 18. Diode Reverse Recovery Time

#### **TYPICAL CHARACTERISTICS**

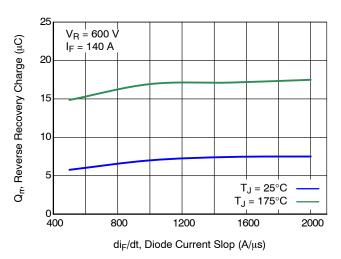


Figure 19. Diode Stored Charge

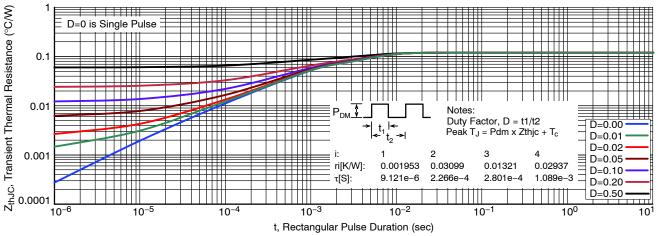


Figure 20. Max Transient Thermal Impedance of IGBT

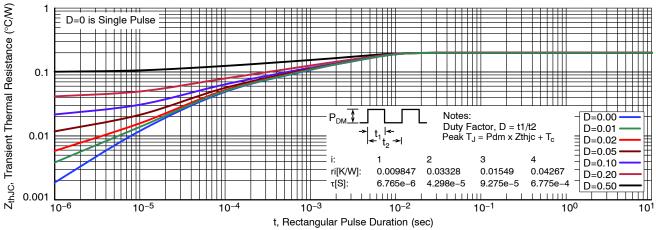
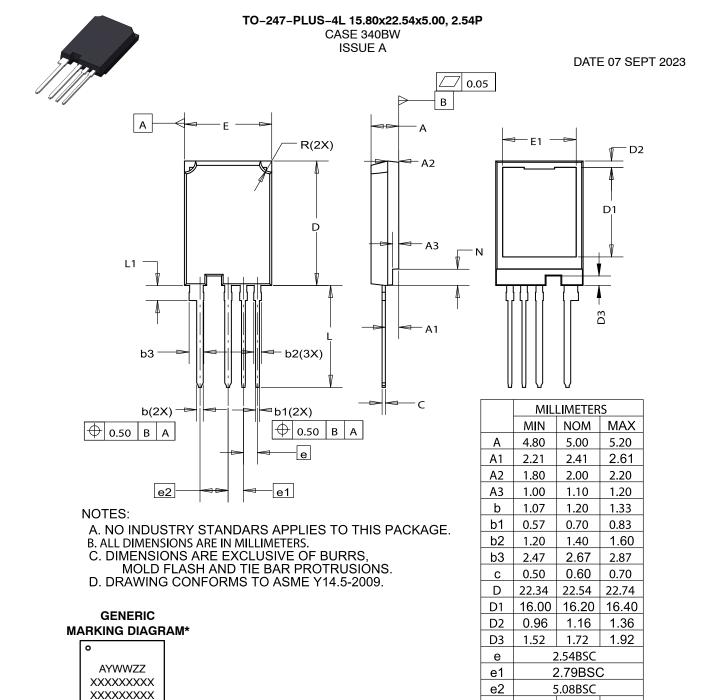


Figure 21. Max Transient Thermal Impedance of Diode





	DESCRIPTION:	: TO-247-PLUS-4L 15.80x22.54x5.00, 2.54P					PAGE -	1 OF 1
DOCUMENT NUMBER: 98AON51847H			Electronic versions are uncontrolled exception Printed versions are uncontrolled exceptions.					
ZZ	= Assembly Lot Co	de not follow the Generic Marking.		N	2.75	2.95	3.15	

\*This information is generic. Please refer to

device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot "■", may

or may not be present. Some products may

Ε

E1

R

15.60

13.10

18.12

2.52

1.90

15.80

13.30

18.42

2.72

2.00

16.00

13.50

18.72

2.92

2.10

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XXXX = Specific Device Code

WW = Work Week

Α

= Assembly Location

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